

MAXIM

3-in-1 Silicon Delay Line

MXD1013

General Description

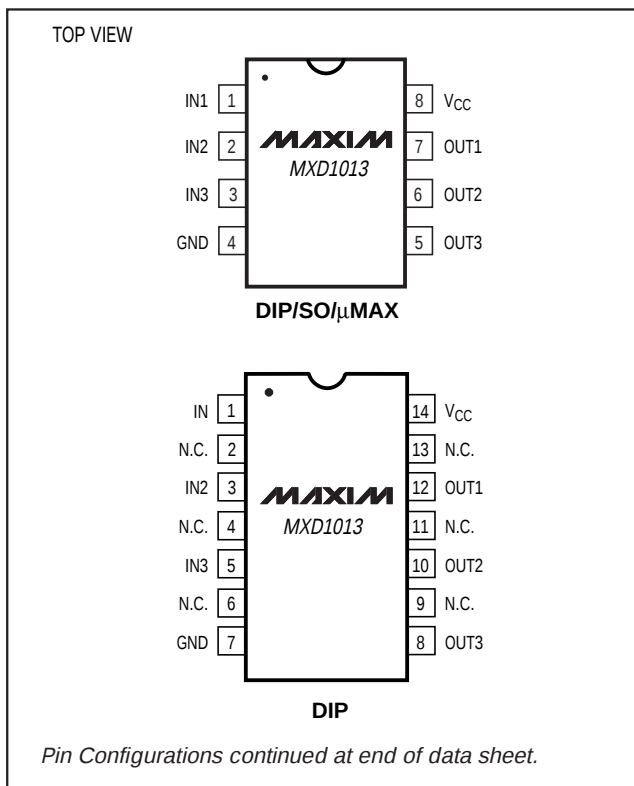
The MXD1013 contains three independent, monolithic, logic-buffered delay lines with delays ranging from 10ns to 200ns. Nominal accuracy is ± 2 ns for a 10ns to 60ns delay, $\pm 3\%$ for a 70ns to 100ns delay, and $\pm 5\%$ for a 150ns to 200ns delay. Relative to hybrid solutions, these devices offer enhanced performance and higher reliability, and reduce overall cost. Each output can drive up to ten standard 74LS loads.

The MXD1013 is available in multiple versions, each offering a different combination of delay times. It comes in the space-saving 8-pin μ MAX package, as well as a standard 8-pin SO and DIP. It is also offered in industry-standard 16-pin SO and 14-pin DIP packaging, allowing full compatibility with the DS1013 and other delay-line products.

Applications

Clock Synchronization
Digital Systems

Pin Configurations



Features

- ◆ Improved Second Source to DS1013
- ◆ Available in Space-Saving 8-Pin μ MAX Package
- ◆ 20mA Supply Current (vs. Dallas' 40mA)
- ◆ Low Cost
- ◆ Three Separate Buffered Delays
- ◆ Delay Tolerance of ± 2 ns for MXD1013__010 through MXD1013__060
- ◆ TTL/CMOS-Compatible Logic
- ◆ Leading- and Trailing-Edge Accuracy
- ◆ Custom Delays Available

Ordering Information

PART	TEMP. RANGE	PIN-PACKAGE
MXD1013C/D___	0°C to +70°C	Dice*
MXD1013PA___	-40°C to +85°C	8 Plastic DIP
MXD1013PD___	-40°C to +85°C	14 Plastic DIP
MXD1013SA___	-40°C to +85°C	8 SO
MXD1013SE___	-40°C to +85°C	16 Narrow SO
MXD1013UA___	-40°C to +85°C	8 μ MAX

*Dice are tested at $T_A = +25^\circ\text{C}$.

Note: To complete the ordering information, fill in the blank with the part number extension from the Part Numbers and Delay Times table to indicate the desired delay per output.

Part Numbers and Delay Times

PART NUMBER EXTENSION (MXD1013__)	OUTPUT DELAY (ns)	PART NUMBER EXTENSION (MXD1013__)	OUTPUT DELAY (ns)
010	10	050	50
012	12	060	60
015	15	070	70
020	20	075	75
025	25	080	80
030	30	090	90
035	35	100	100
040	40	150	150
045	45	200	200

Functional Diagram appears at end of data sheet.

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ABSOLUTE MAXIMUM RATINGS

V_{CC} to GND-0.5V to +6V
 All Other Pins-0.5V to (V_{CC} + 0.5V)
 Short-Circuit Output Current (1sec)50mA
 Continuous Power Dissipation (T_A = +70°C)
 8-Pin Plastic DIP (derate 9.1mW/°C above +70°C)727mW
 14-Pin Plastic DIP (derate 10.0mW/°C above +70°C) ...800mW

8-Pin SO (derate 5.9mW/°C above +70°C).....471mW
 16-Pin Narrow SO (derate 8.7mW/°C above +70°C)696mW
 8-Pin μ MAX (derate 4.1mW/°C above +70°C)330mW
 Operating Temperature Range-40°C to +85°C
 Storage Temperature Range-65°C to +160°C
 Lead Temperature (soldering, 10sec)+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{CC} = +5.0V $\pm$ 5%, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at T_A = +25°C.)(Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage	V _{CC}	(Note 2)	4.75	5.00	5.25	V
Input Voltage High	V _{IH}	(Note 2)	2.2			V
Input Voltage Low	V _{IL}	(Note 2)			0.8	V
Input Leakage Current	I _L	0V $\leq$ V _{IN} $\leq$ V _{CC}	-1		1	μ A
Active Current	I _{CC}	V _{CC} = 5.25V, period = minimum (Note 3)		20	70	mA
Output Current High	I _{OH}	V _{CC} = 4.75V, V _{OH} = 4.0V			-1	mA
Output Current Low	I _{OL}	V _{CC} = 4.75V, V _{OL} = 0.5V	12			mA
Input Capacitance	C _{IN}	T _A = +25°C (Note 4)		5	10	pF

TIMING CHARACTERISTICS

(V_{CC} = +5.0V $\pm$ 5%, T_A = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Pulse Width	t _{WI}	(Note 5)	100% of t _{PLH}			ns
Input-to-Output Delay (leading edge)	t _{PLH}	(Notes 6, 7, 8)	See Part Number and Delay Times table			ns
Input-to-Output Delay (trailing edge)	t _{PHL}	(Notes 6, 7, 8)	See Part Number and Delay Times table			ns
Power-Up Time	t _{PU}				100	ms
Period		(Note 5)	3(t _{WI})			ns

Note 1: Specifications to -40°C are guaranteed by design, not production tested.

Note 2: All voltages referenced to GND.

Note 3: Measured with outputs open.

Note 4: Guaranteed by design.

Note 5: Pulse width and/or period specifications may be exceeded, but accuracy is application sensitive (i.e., layout, decoupling, etc.).

Note 6: V_{CC} = +5V at +25°C. Typical delays are accurate on both rising and falling edges within $\pm$ 2ns for delays from 10ns to 60ns, within $\pm$ 3% for delays from 70ns to 100ns, and within $\pm$ 5% for delays from 150ns to 200ns.

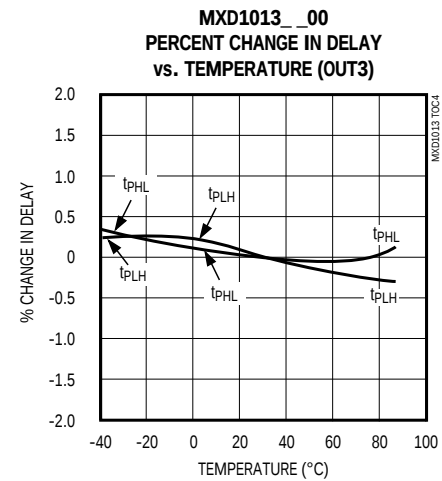
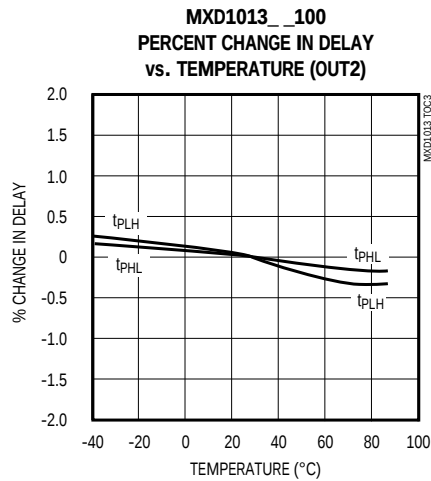
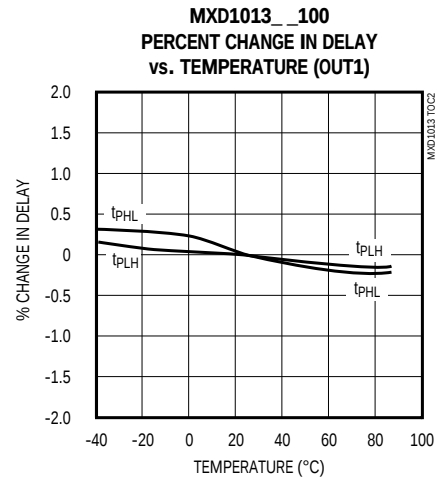
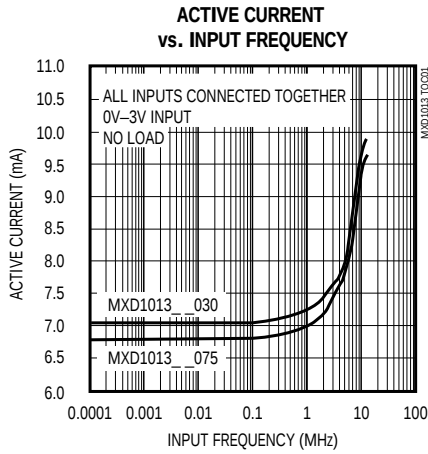
Note 7: The *Part Number and Delay Times* table provides typical delays at +25°C with V_{CC} = +5V. The delays may shift with temperature and supply variations. The combination of temperature (from +25°C to 0°C, or +25°C to +70°C) and supply variation (from 5V to 4.75V, or 5V to 5.25V) could produce an additional typical delay of $\pm$ 1.5ns or $\pm$ 3%, whichever is greater.

Note 8: All output delays tend to vary unidirectionally with temperature or supply voltage variations (i.e., if OUT1 slows down, all other outputs also slow down).

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Typical Operating Characteristics

($V_{CC} = +5V$, $T_A = +25^\circ C$, unless otherwise noted.)



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Pin Description

PIN			NAME	FUNCTION
8-PIN DIP/SO/ μ MAX	14-PIN DIP	16-PIN SO		
1	1	1	IN1	First Independent Input
2	3	4	IN2	Second Independent Input
3	5	6	IN3	Third Independent Input
4	7	8	GND	Device Ground
5	8	9	OUT3	Third Delayed Output
6	10	11	OUT2	Second Delayed Output
7	12	13	OUT1	First Delayed Output
8	14	16	VCC	Power-Supply Input
—	2, 4, 6, 9, 11, 13	2, 3, 5, 7, 10, 12, 14, 15	N.C.	Not Connected

Definitions of Terms

Period: The time elapsed between the first pulse's leading edge and the following pulse's leading edge.

Pulse Width (t_{WI}): The time elapsed on the pulse between the 1.5V level on the leading edge and the 1.5V level on the trailing edge, or vice versa.

Input Rise Time (t_{RISE}): The elapsed time between the 20% and 80% points on the input pulse's leading edge.

Input Fall Time (t_{FALL}): The time elapsed between the 80% and 20% points on the input pulse's trailing edge.

Time Delay, Rising (t_{PLH}): The time elapsed between the 1.5V level on the input pulse's leading edge and the corresponding output pulse's leading edge.

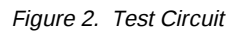
Time Delay, Falling (t_{PHL}): The time elapsed between the 1.5V level on the input pulse's trailing edge and the corresponding output pulse's trailing edge.

Test Conditions

Ambient Temperature:	+25°C
Supply Voltage (V_{CC}):	5.0V $\pm$ 0.1V
Input Pulse:	High = 3.0V $\pm$ 0.1V Low = 0.0V $\pm$ 0.1V
Source Impedance:	50 Ω max
Rise and Fall Times:	3.0ns max
Pulse Width:	500ns max
Period:	1 μ s

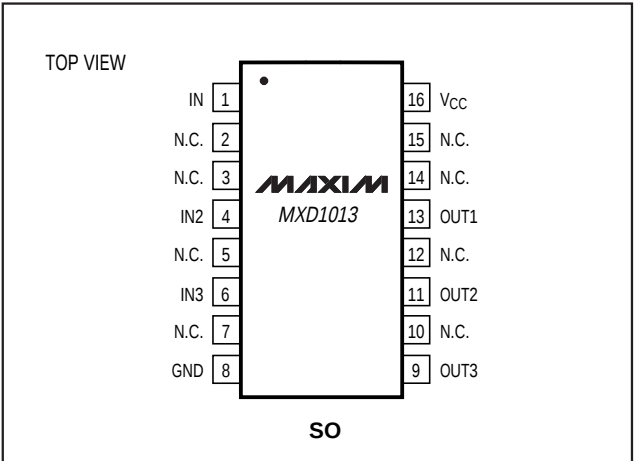
Each output is loaded with a 74F04 input gate. Delay is measured at the 1.5V level on the rising and falling edges. The time delay due to the 74F04 is subtracted from the measured delay.

MXD1013

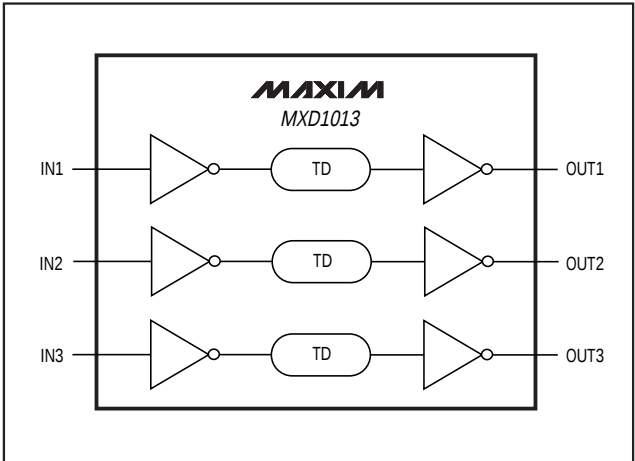


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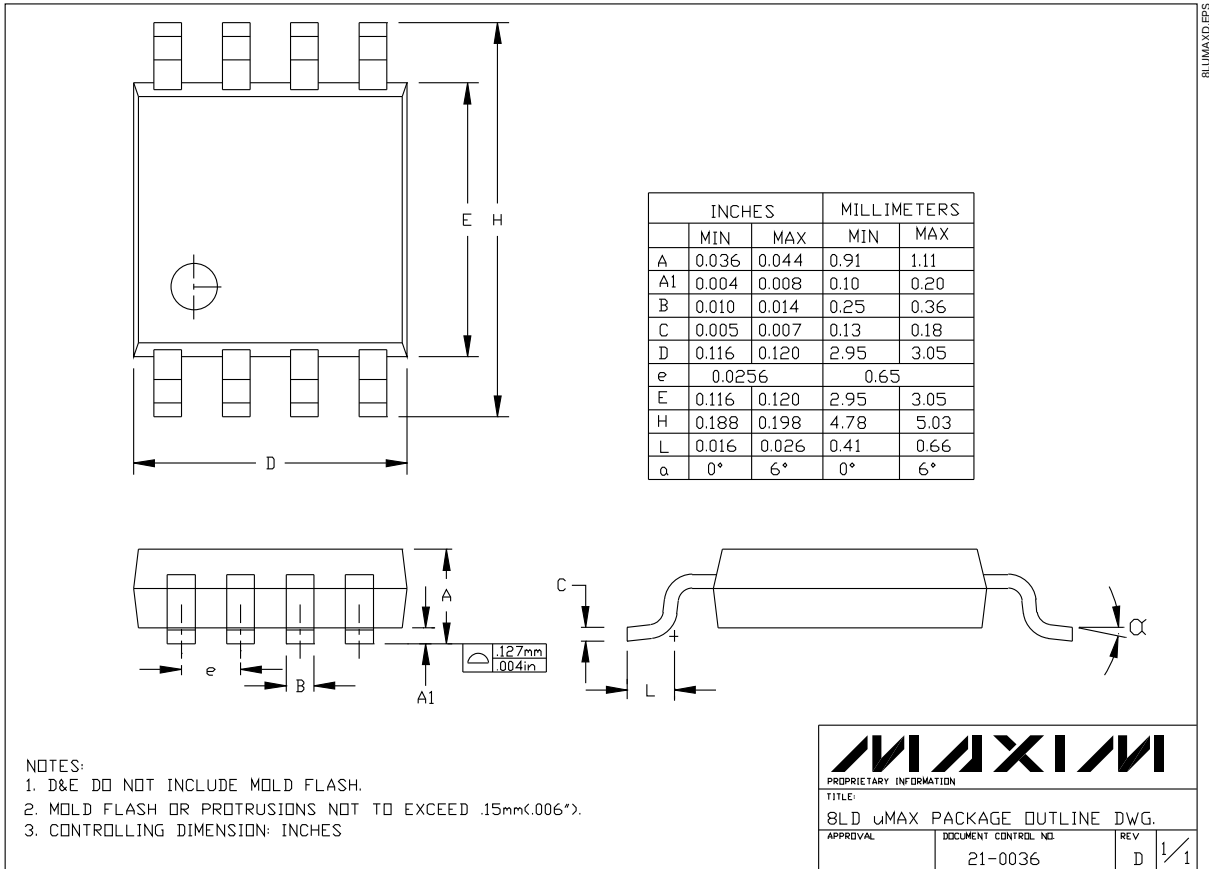
Pin Configurations (continued)



Functional Diagram



Package Information



Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

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